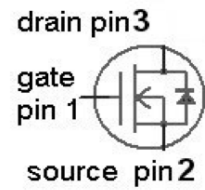
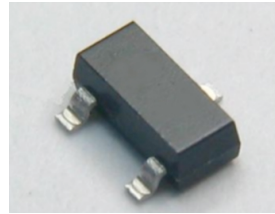


DMS05N60 N-Channel Depletion-Mode MOSFET

FEATURES

- Depletion Mode (Normally On)
- Advanced Planar Technology
- Rugged Poly-silicon Gate Cell Structure
- Fast Switching Speed
- RoHS Compliant/Lead Free
- ESD Sensitive



Applications

- Normally-on Switches
- SMPS start-up Circuit
- Linear Amplifier
- Converters
- Constant Current Source
- Telecom

| | | |
|------------|---------------------|---------------|
| BV_{DSX} | $R_{DS(ON)}$ (Max.) | $I_{DSS,min}$ |
| 600V | 700Ω | 12mA |

RoHS
COMPLIANT

HALOGEN
FREE
Available

Absolute Maximum Ratings

$T_A=25^{\circ}\text{C}$ unless otherwise specified

| Symbol | Parameter | DMS05N60 | Unit |
|---------------------|---|----------|------|
| V_{DSX} | Drain-to-Source Voltage ^[1] | 600 | V |
| V_{DGX} | Drain-to-Gate Voltage ^[1] | 600 | V |
| I_D | Continuous Drain Current | 0.020 | A |
| I_{DM} | Pulsed Drain Current | 0.081 | |
| P_D | Power Dissipation | 0.50 | W |
| V_{GS} | Gate-to-Source Voltage | ±20 | V |
| T_L | Soldering Temperature Distance of 1.6mm from case for 10 seconds | 300 | °C |
| T_J and T_{STG} | Operating and Storage Temperature Range | -55~150 | |

Caution: Stresses greater than those listed in the “Absolute Maximum Ratings” may cause permanent damage to the device.

Thermal Characteristics

| Symbol | Parameter | DMS05N60 | Unit |
|-----------------|---|----------|------|
| $R_{\theta JA}$ | Thermal Resistance, Junction-to-Ambient | 250 | K/W |



DMS05N60 N-Channel Depletion-Mode MOSFET

Electrical Characteristics

OFF Characteristics

TA=25°C unless otherwise specified

| Symbol | Parameter | Min. | Typ. | Max. | Unit | Test Conditions |
|---------------------|-----------------------------------|------|------|------|------|--|
| BV _{DSX} | Drain-to-Source Breakdown Voltage | 600 | -- | -- | V | V _{GS} =-5V, I _D =250μA |
| I _{D(OFF)} | Drain-to-Source Teakage Current | -- | -- | 0.1 | μA | V _{DS} =600V, V _{GS} =-5V |
| | | -- | -- | 10 | μA | V _{DS} =600V, V _{GS} =-5V T _J =125°C |
| I _{GSS} | Gate-to-Source Leakage Current | -- | -- | 100 | nA | V _{GS} =+20V, V _{DS} =0V |
| | | -- | -- | -100 | | V _{GS} =-20V, V _{DS} =0V |

ON Characteristics

TA=25°C unless otherwise specified

| Symbol | Parameter | Min. | Typ. | Max. | Unit | Test Conditions |
|----------------------|--------------------------------------|------|------|------|------|---|
| I _{DSS} | Saturated Drain-to-Source Current | 12 | -- | -- | mA | V _{GS} =0V, V _{DS} =25V |
| R _{DS(ON)} | Static Drain-to-Source On-Resistance | -- | 500 | 700 | Ω | V _{GS} =0V, I _D =3Ma ^[4] |
| V _{GS(OFF)} | Gate-to-Source Cut-off Voltage | -2.7 | -- | -1.5 | V | V _{DS} =3V, I _D =8μA |
| gfs | Forward Transconductance | -- | 15.4 | -- | mS | V _{DS} =10V, I _D =5mA |

Dynamic Characteristics

Essentially independent of operating temperature

| Symbol | Parameter | Min. | Typ. | Max. | Unit | Test Conditions |
|------------------|-------------------------------|------|------|------|------|---|
| C _{ISS} | Input Capacitance | -- | 12.3 | -- | Pf | V _{GS} =-5V V _{DS} =25V f=1.0MHz |
| C _{OSS} | Oput Capacitance | -- | 2.6 | -- | | |
| C _{RSS} | Reverse Transfer Capacitance | -- | 1.8 | -- | | |
| Q _G | Total Gate Charge | -- | 1.55 | -- | nC | V _{GS} =-5V~5V V _{DS} =300V, I _D =5mA |
| Q _{GS} | Gate-to-Source Charge | -- | 0.12 | -- | | |
| Q _{GD} | Gate-to-Drain (Miller) Charge | -- | 0.56 | -- | | |

Resistive Switching Characteristics

Essentially independent of operating temperature

| Symbol | Parameter | Min. | Typ. | Max. | Unit | Test Conditions |
|---------------------|---------------------|------|------|------|------|--|
| T _{d(ON)} | Turn-on Delay Time | -- | 4 | -- | ns | V _{GS} =-5V~5V V _{DD} =300V, I _D =5Ma R _G =20Ohm |
| T _{rise} | Rise Time | -- | 9 | -- | | |
| t _{d(OFF)} | Turn-off Delay Time | -- | 14 | -- | | |
| t _{fall} | Fall Time | -- | 84 | -- | | |

Source-Drain Diode Characteristics

TA=25°C unless otherwise specified

| Symbol | Parameter | Min. | Typ. | Max. | Unit | Test Conditions |
|-----------------|-----------------------|------|------|------|------|---|
| V _{SD} | Diode Forward Voltage | -- | -- | 1.2 | V | I _{SD} =3.0mA, V _{GS} =-10V |

NOTE:

[1] T_J=+25°C to +150°C

[2] Repetitive rating, pulse width limited by maximum junction temperature.

[3] Pulse width ≤ 380 μs ; duty cycle ≤ 2%

DMS05N60 N-Channel Depletion-Mode MOSFET

- Characteristic Curves

